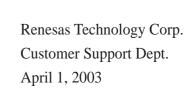
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2SD1976

Silicon NPN Triple Diffused



ADE-208-918 (Z) 1st. Edition September 2000

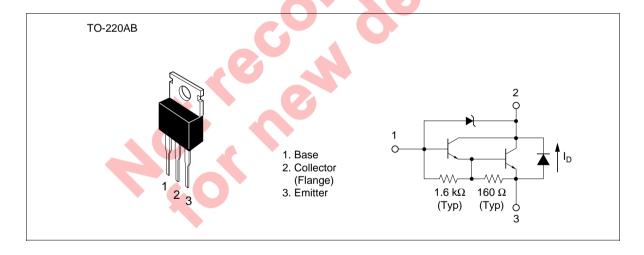
Application

High voltage switching, igniter

Feature

- Built-in High voltage zener diode (300 V)
- High Speed switching

Outline



2SD1976

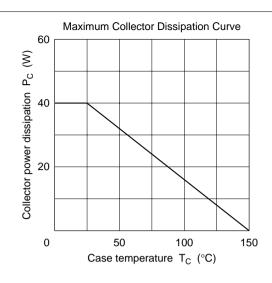
Absolute Maximum Ratings (Ta = 25°C)

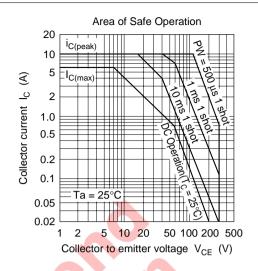
Item	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	300	V
Collector to emitter voltage	V_{CEO}	300	V
Emitter to base voltage	V _{EBO}	7	V
Collector current	I _c	6	A
Diode current	I_D^{*1}	6	A
Collector peak current	I _{C(peak)}	10	A
Collector power dissipation	P _c *1	40	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

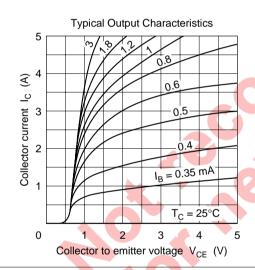
Note: 1. Value at $T_c = 25^{\circ}C$.

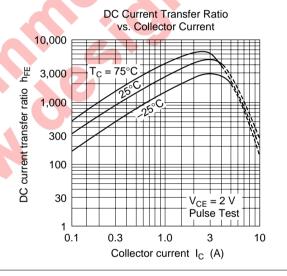
Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	300		420	V	$I_{c} = 0.1 \text{ mA}, I_{E} = 0$
Collector to emitter sustain voltage	V _{CEO(SUS)}	300	_	U	V	$I_{c} = 3 \text{ A}, R_{BE} = \infty, L = 10 \text{ mH}$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	1	_	V	$I_{\rm E} = 50 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CEO}	- (<u> </u>	100	μΑ	V _{CE} = 300 V, R _{BE} = ∞
DC current transfer ratio	h _{FE}	500	_	_		$V_{CE} = 2 \text{ V}, I_{C} = 4 \text{ A}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$		_	1.5	V	$I_{\rm C} = 4 \text{ A}, I_{\rm B} = 40 \text{ mA}$
Base to emitter saturation voltage	V _{BE(sat)}	_	_	2.0	V	I _C = 4 A, I _B = 40 mA
Emitter to collector diode forward voltage	V _{ECF}	_	_	3.5	V	I _F = 6 A
Turn on time	t _{on}	_	1.2	_	μs	I _C = 4 A, V _{CC} = 20 V
Storage time	t _{stg}	_	8.0		_	$I_{B1} = -I_{B2} = 40 \text{ mA}$
Fall time	t _f	_	8.0	_		

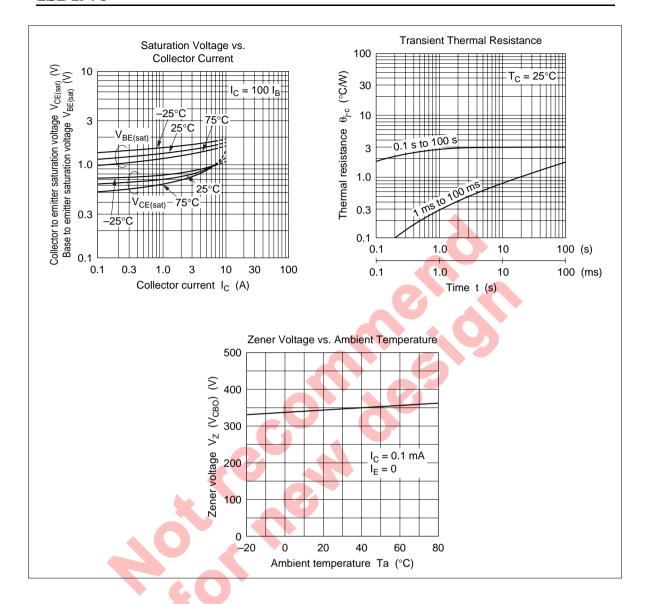








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